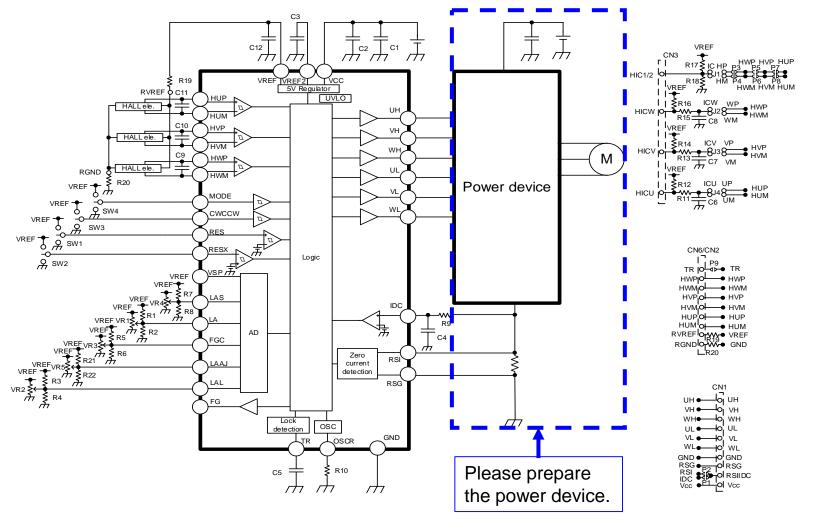
TOSHIBA

Circuit diagram - TC78B042FTG -



Note: SW2 (RESX) and C3 (VREF2) are only in TC78B042FTG and are not in TC78B041FNG.

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